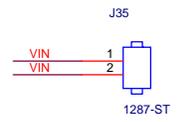
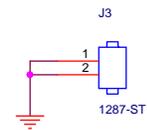
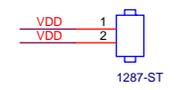
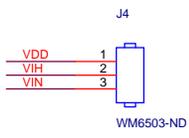
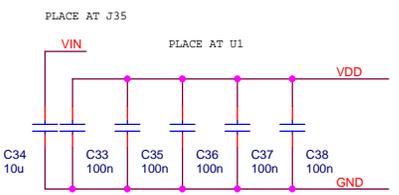
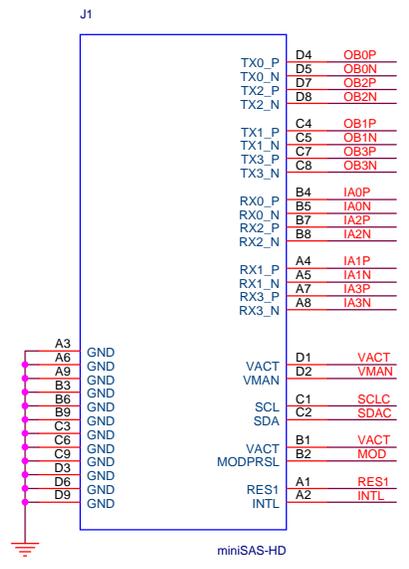
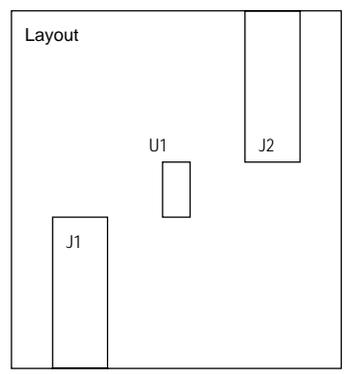
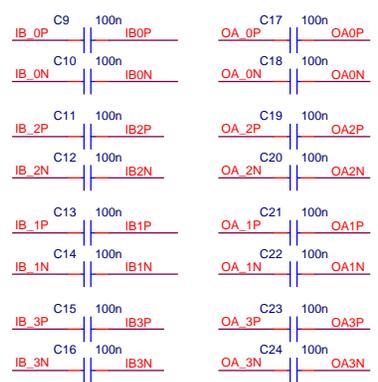
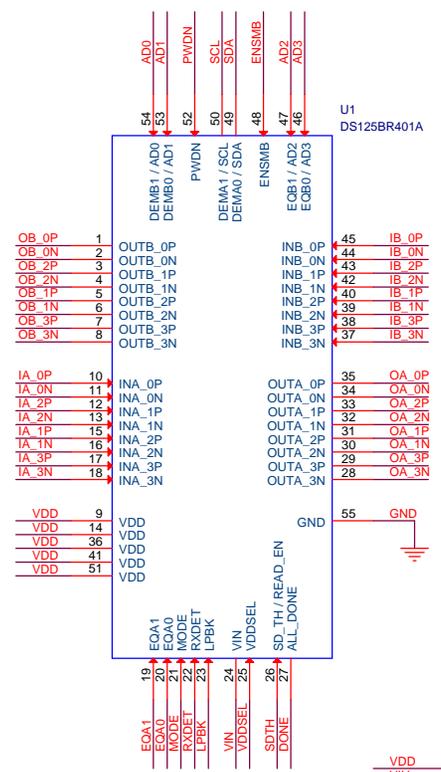
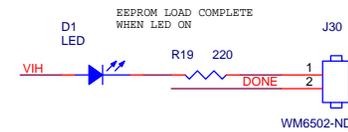
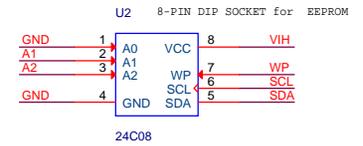
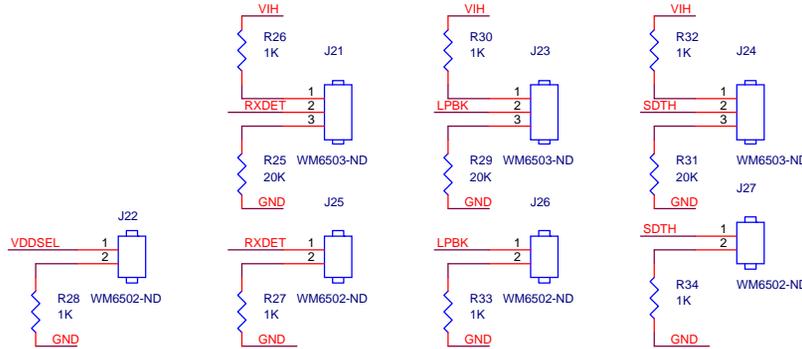
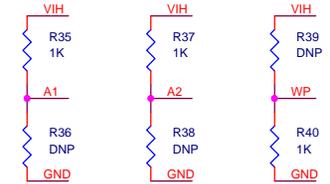
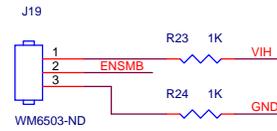
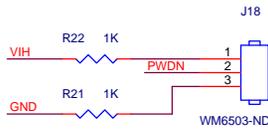
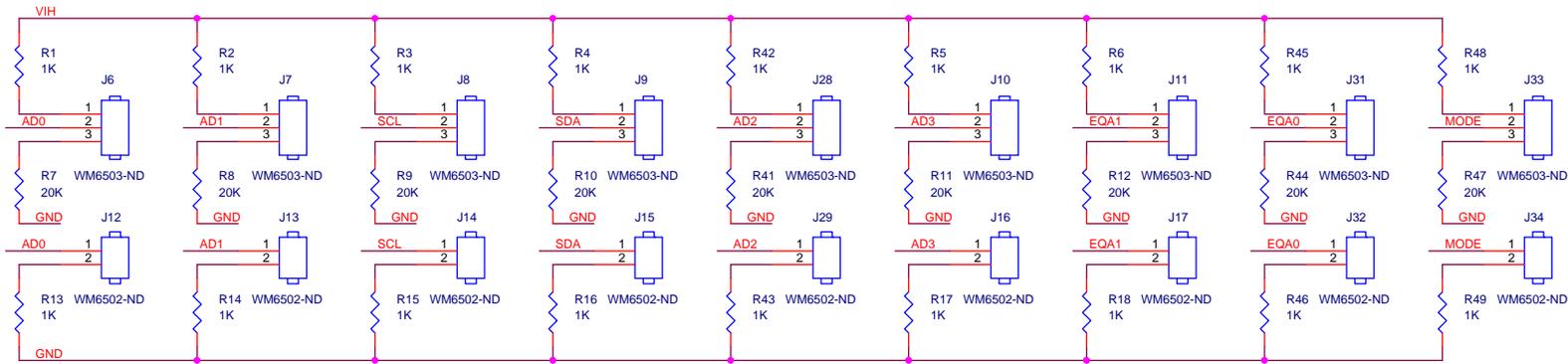


Connector Notes:

- VACT pin is a power pin for active cables. This needs a low impedance (power) connection from J1 to J2.
- VMAN pin is a power pin for cable management. This needs a low impedance (power) connection from J1 to J2.



Title		
TIDA-00425		
Size	Document Number	Rev
B	12 Gbps SAS-3 Link Extender	A
Date:	Wednesday, July 08, 2015	Sheet 1 of 1



Title		TIDA-00425	
Size	Document Number	12 Gbps SAS-3 Link Extender	
B			Rev A
Date:	Wednesday, July 08, 2015	Sheet	1 of 1

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